Jun YANG

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EDUCATION

SEP. 2020- | Tsinghua University, Weiyang College

Beijing, China

Jun. 2024 B.Sc. & B.Eng.

Major: Mathematics and Physics + Electrical Engineering and Automation

GPA: 3.91/4.0

Jan. 2023 | Shanghai Jiao Tong University, The 12th Computational Neuroscience Winter

School

A one-week online winter school on computational neuroscience

Jul. 2024 | CNeuro 2024, Theoretical and Computational Neuroscience Summer School

A one-week online winter school on computational neuroscience organized by Tsinghua Laboratory of Brain & Intelligence (THBI) and Institute of Molecular & Clinical Ophthalmology Basel (IOB).

RESEARCH INTERESTS

Theoretical Neuroscience, Nonlinear Dynamics

RESEARCH EXPERIENCE

Jul. 2023- UCLA, Summer Internship

PRESENT | Advisor: Mayank R. Mehta, Department of Physics

Analyzed Visual Coding - Neuropixels dataset in Allen Brain Observatory and found loco-

motion enhances movie selectivity of visual and hippocampal areas.

Jul. 2022– New York University Shanghai, Research Assistant

Present | Advisor: Sukbin Lim, Department of Neural Science

Built an attractor network model that bridges the oblique effect and cardinal biases in visual working memory. Explained the variance profile which seemingly contradicts attractor

dynamics.

Feb. 2022- | Tsinghua University, "Spark" Innovative Talent Cultivation Program

Jun. 2022 Advisor: Pei Sun, Department of Psychology

Investigated the information routing patterns in a Kuramoto oscillator network.

PREPRINTS

• J. Yang, H. Zhang, and S. Lim. (2024). Sensory-memory interactions via modular structure explain errors in visual working memory [Reviewed preprint version 1]. eLife. https://doi.org/10.7554/eLife.95160.1

POSTER PRESENTATIONS

• J. Yang, H. Zhang, and S. Lim. Cardinal repulsion in working memory requires sensory-memory network interactions. Program No. 169.03. Washington, D.C.: Society for Neuroscience (SfN), Nov. 11-15, 2023.

SCHOLARSHIPS AND AWARDS

2020–2022 Scholarship of Academic Excellence, Tsinghua University

2021–2023 Scholarship of Scientific or Technological Innovation Excellence, Tsinghua University

TECHNICAL SKILLS

MATLAB, C, Python (NumPy, CuPy, SciPy, scikit-learn, PyTorch, CVXPY), Git, Verilog, Simulink, Wolfram Mathematica, IAT_FX, Typst, MatCont, AUTO